

Metrology challenges for highly parallel micro-manufacture

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4M, San Sebastian, Spain October 2013

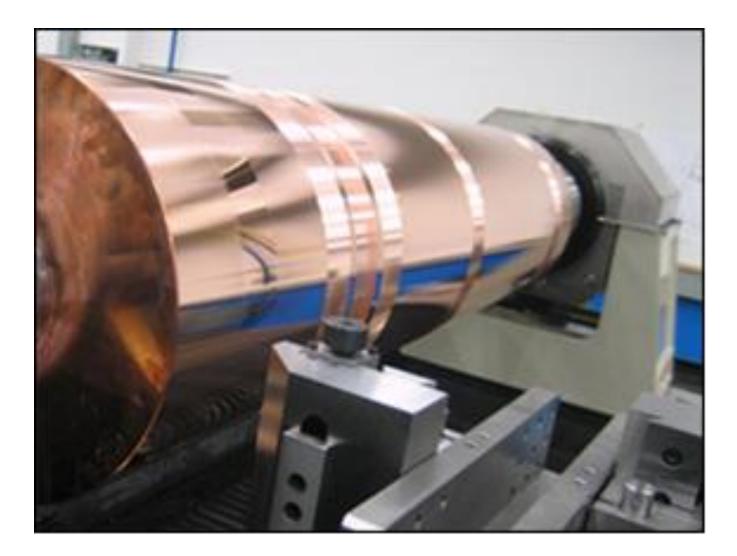
Content of talk



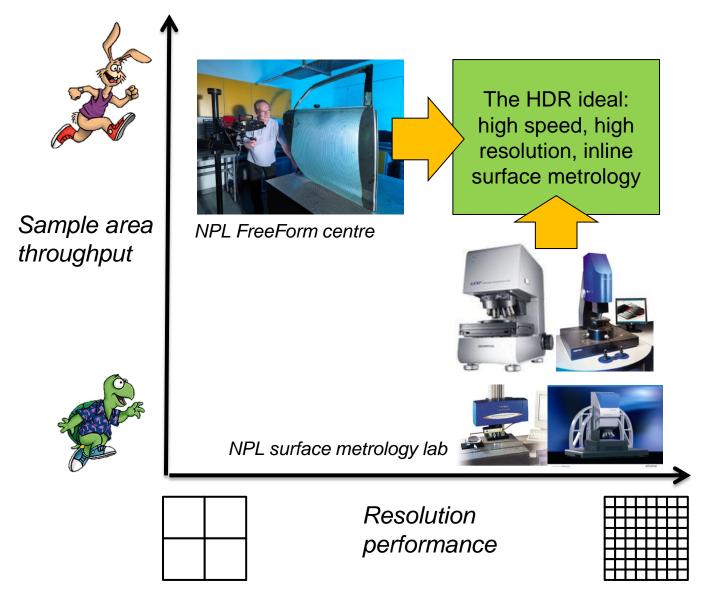
- Introduction to HDR metrology
- Point sensors
- Areal sensors
- Super-resolution
- HDR conclusions
- Other areas of interest

An illustrative example













Sample area throughput



HDR ideal: Fast, hi-res, inline metrology

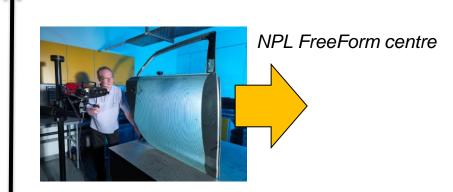
- Photovoltaics
- Micro-optics
- Printed/plastic electronics
- Coated paperboard
- Glass manufacture





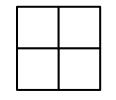


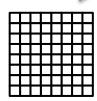
Sample area throughput



- ✓ high throughput
- ✓ complete image
- ✓ proven inline metrology
- resolution for MNT
- surface tolerance for MNT









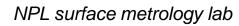


Sample area throughput

 \checkmark complete image

- ✓ resolution for MNT
- \checkmark surface tolerance for MNT
- x inline metrology (for now)
- very low throughput







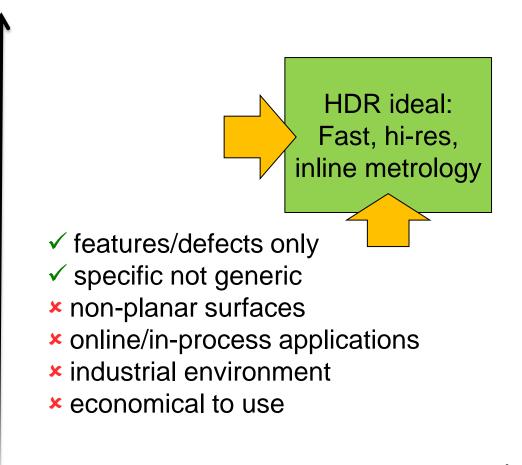


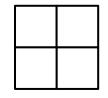




Sample area throughput

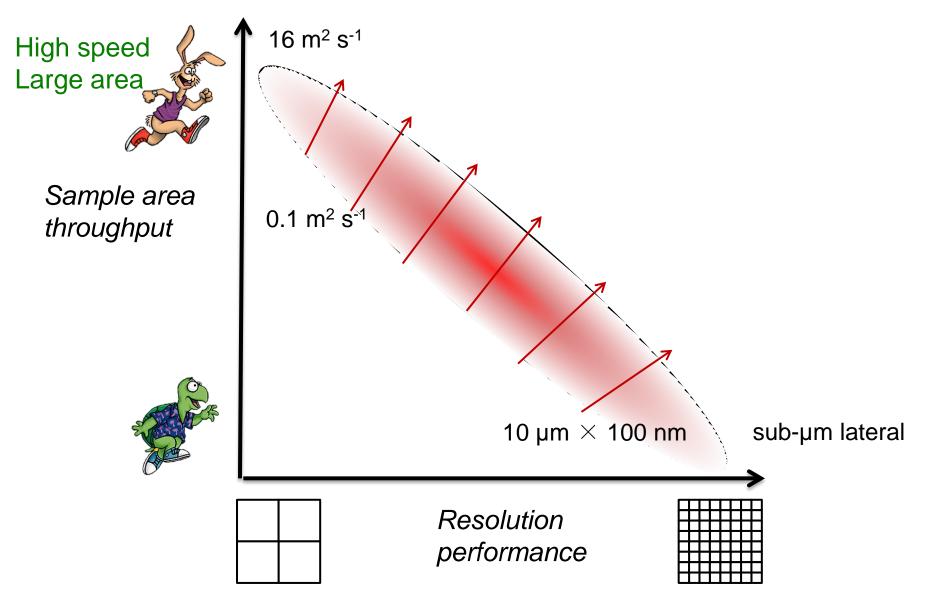




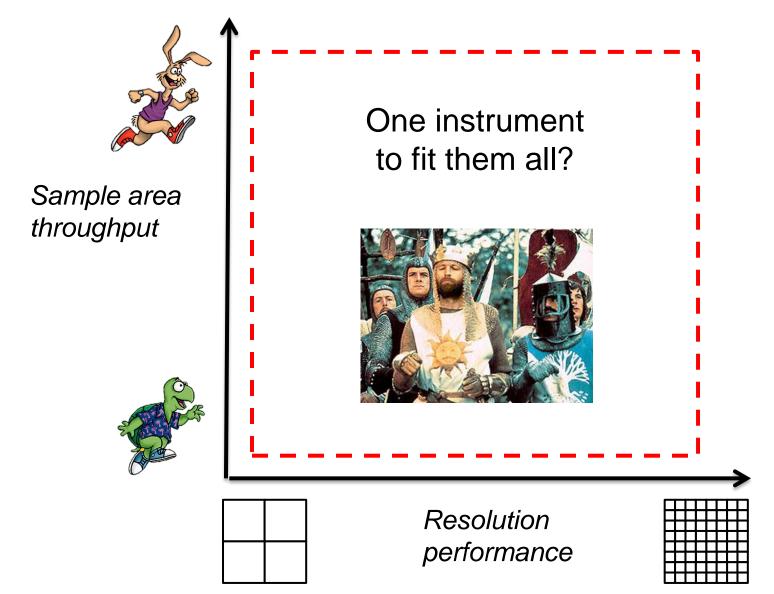




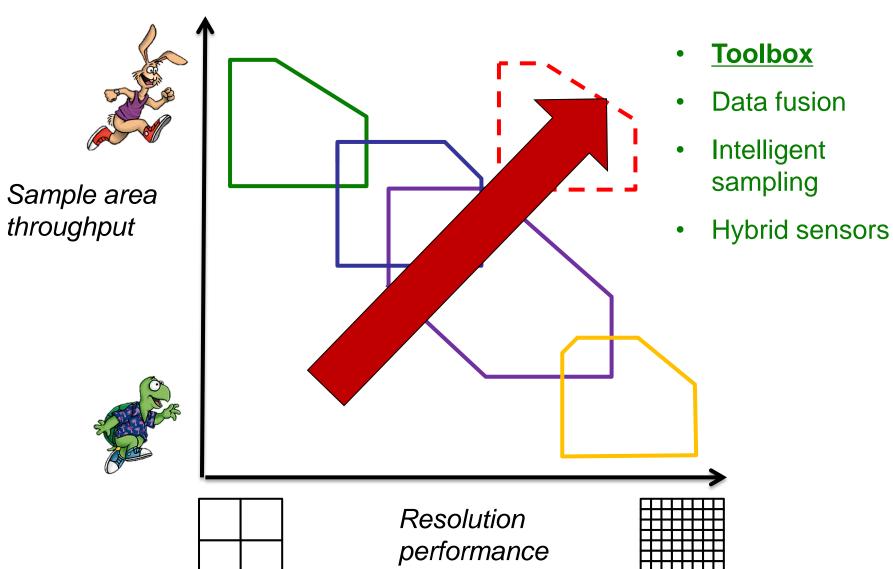






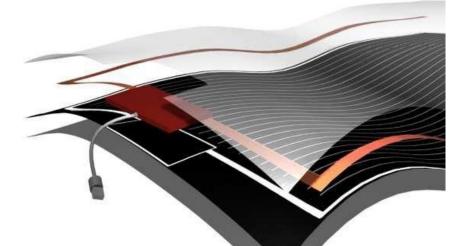








www.nanomend.eu





Flexible Solar modules

Image courtesy of Flisom

The inside of food and liquid packaging

Image courtesy of Stora Enso

Detection – cleaning – repair



The NANOMend (formerly NANOCleaR) project has received funding from the European Community's Seventh Framework Program (FP7/2007-2013) under Grant Agreement No. 280581



Metrology challenges

- Increase the speed of high-resolution sensors
 → overcome conflict between speed and resolution.
- Overcome the limit on the smallest detectable defect
 resolution enhancement for fast sensors
- Prioritise defects to simplify inspection and measurement
- Find better ways to apply and test protective thin films themselves





Recent progress in the consortium*

- Detailed defect analysis for each application
 functional significance assigned to each defect classification
- Wavelength scanning interferometer (WSI) capable of nanometre resolution for inline defect inspection and metrology
- Pragmatic yet ISO-compliant calibration and verification procedures developed
- New metrology tools for beyond the immediate studies:
 - WSI for a moving web
 - resolution enhancement
- Various other achievements in functional barrier application and traceable testing.





Wavelength scanning interferometer (WSI)

Huddersfield

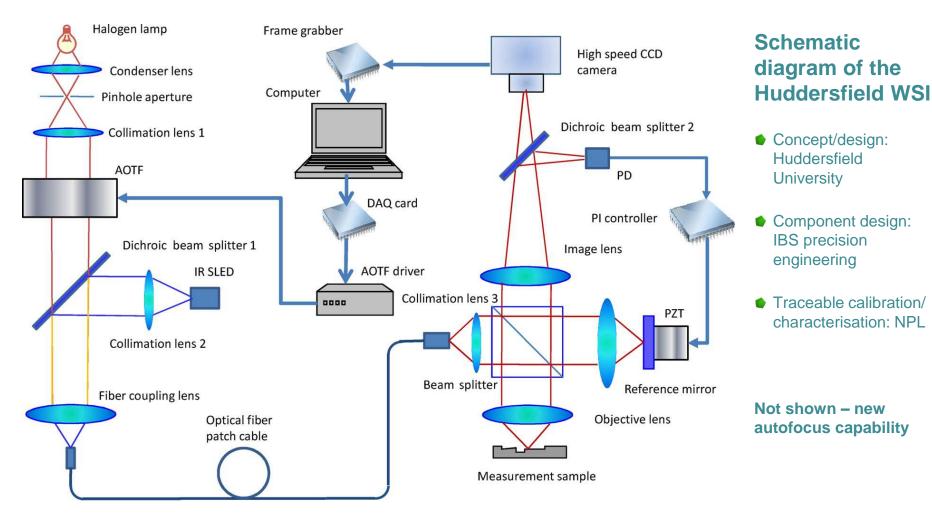
IBS precision

engineering

Component design:

characterisation: NPL

University



Jiang X, Wang K, Gao F, and Muhamedsalih H 2010 Applied Optics 49 2903-2909 Gao F, Muhamedsalih H and Jiang X 2012 Optics Express 20 21450-21456 Muhamedsalih H, Gao F and Jiang X 2012 Applied Optics 51 8854-8862



Point probes for HDR metrology

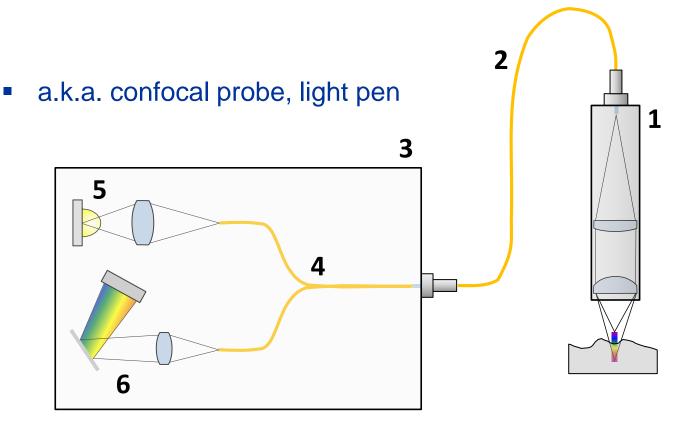
What is a point probe?



- Detects axial position of surface at a single point Fast z scan ... or 'optical scale'
- 'Optical stylus'
- Complete required surface measurement using multiple profiles (far too slow? c.f. stylus instruments)
- Example: chromatic confocal probe

Example: chromatic confocal probe





Schema of a chromatic confocal probe system: (1) The probe (final optics); (2) optical fibre connection; (3) the controller unit; (4) optical Y-couple; (5) white light source and (6) the spectrometer, in which displacements, encoded as wavelengths of light, are directed onto an array of pixels (from [5]).

Rithard Leach Editor Optical Measurement of Surface Topography

Example: chromatic confocal probe

- Measurement rate limited by CCD operation (DSP, illumination levels, typically ~10 kHz)
- Heavily used as inline non-contact height gauge
 → ✓ robust, ✓ multiple suppliers, ✓ integration,
 ✓ standoff

(but not perfect)

 Sensor + scanning system: high resolution surface topography







- High resolution *tactile* (point) measurements very slow
 Very slow: 1 mm² takes ~ minutes for 2.5D measurement
- Laser scanning confocal microscope
 Piezo-controlled 3D scan of spot
 Faster: 1 mm² takes seconds for 2.5D measurement
- HDR needs > 10⁴ faster new approach needed



Solution:

Prior knowledge \rightarrow simplified measurement

Reduce dense 2D scan to representative profiles



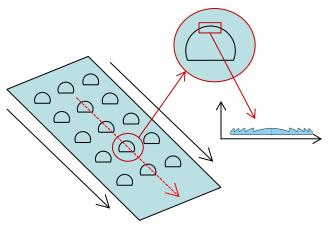
Not new idea - skill is in the reduction method

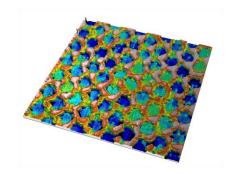
Best for:

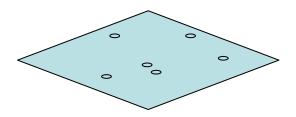
Linear features in known location (e.g. CAD) Known symmetry of design

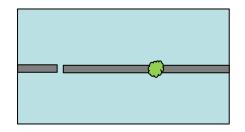


- Suitable HDR applications?
 - 100 % surface topography measurement
 - ✓ Form inspection for micro-optics
 - Search for dispersed random defects
 - ✓ Continuity defects in linear features











Pessimistic max speed?

- ✓ Fewer points acceptable?
- ✓ Faster probes being developed 70 kHz
- ✓ Parallel probing line scanners
- Optimistic max speed?
 - Real samples are dark
 - Solution State And Stat
 - Sampling holding / motion problems

Conclusions point sensing



- Point sensors + brute force measurement → ×
- Point sensors + careful measurement simplification $\rightarrow \checkmark$

... in some important applications

- i.e. smarter measurement critical to success in HDR surface metrology and inspection applications
- A priori knowledge critical for use of point sensors in HDR applications
- Independent benchmarking will assist in choosing sensors under development at NPL



High resolution areal sensors: where we are?

Review stage



Focus - common surface topography measurement techniques

- o CCM,
- o point autofocus,
- o confocal microscopy,
- o DHM,
- o WLI,
- o PSI,
- o FVI,
- o ptychography,
- Aim classification of limitations

Review findings



- Significant shortcomings in measurement throughput.
- > Axial scanning to be avoided.
- Significant challenge:

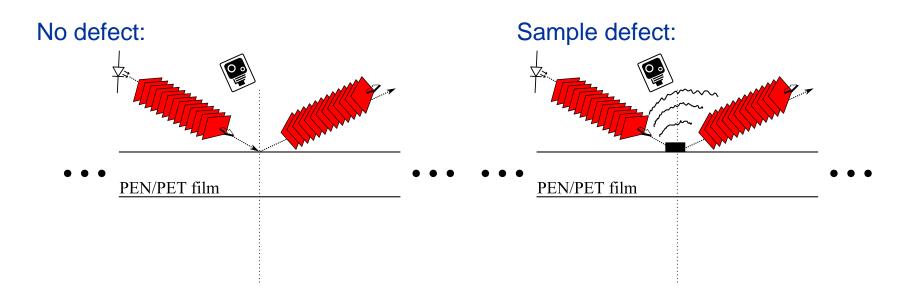
HDR samples typically incorporate all the problematic features one can imagine



DARK-FIELD IMAGING



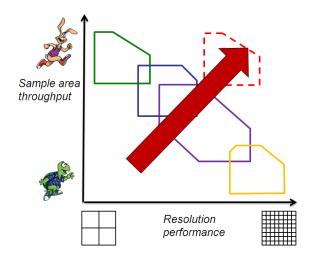
Dark-field imaging (scattered radiation) should return information on the localisation of areas of interest with reasonable resolution.



DARK-FIELD IMAGING



- TARGET CONFIGURATION: single-line CMOS detector arrangement to cover entire sample
 - $\,\circ\,\,$ lateral resolution with available hardware limited to ~5 to 50 μm



• expected data count for 16k pixel detector ~1 GB/s

DARK-FIELD IMAGING NEAR FUTURE



- verify concept of single image-frame defect detection;
- verify how far we can push the detection and what is the primary limiting factor;
 - defects smaller then lateral resolution are expected to be visible;
- investigate angular responses of such a configuration;
- investigate responses of such a configuration to multiple wavelength illumination.

BRIGHT-FIELD IMAGING



In presence of a defect, intensity of recorded radiation should depend on the pair - the depth of the feature and wavelength of illumination. This is due to changes in phase differences for a given depth with regard to the wavelength.

• For this reason, with carefully selected illumination conditions additional information about defect should be accessible.

BRIGHT-FIELD IMAGING (2) A BIT MORE DISTANT FUTURE



Conduct experiments to check and learn:

- if said differences at normal incidence illumination can be detected.
- how to select optimal wavelengths.
- how illumination source type influences the 'measurement'.



Resolution enhancement

Super-resolution – The NPL view



- SR is the recovery of object information that is lost during the imaging process
- Strictly, SR is the recovery of spatial frequencies that exceed the bandwidth of the imaging system transfer function.
- SR techniques broadly fall into three categories:
 - Computational
 - PSF engineering
 - Fluorescence based (Stimulated emission depletion, nonlinear saturated structured illumination, photo-activated localisation, stochastic optical reconstruction)
- At NPL we aim to maximally exploit a priori knowledge of the object to enhance the image resolution
- Computational SR techniques show promise for on-line defect detection



- Manufactured surfaces often accompanied by information that describes what they should look like
- This a priori knowledge is a powerful ally in quest for SR
- Example: 2D model fitting approach
- A priori knowledge: we are looking at 3 rectangles (size, shape, position and orientation unknown)



Object (three identical rectangles with a different reflectance to the uniform background)

0.9

0.8

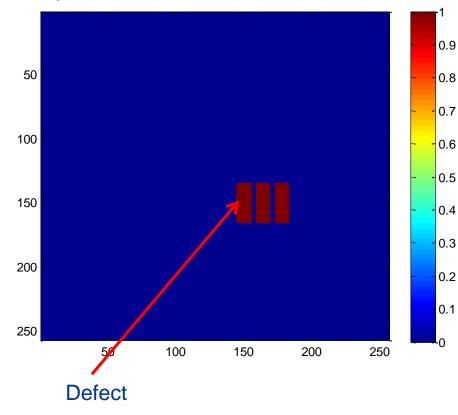
0.6

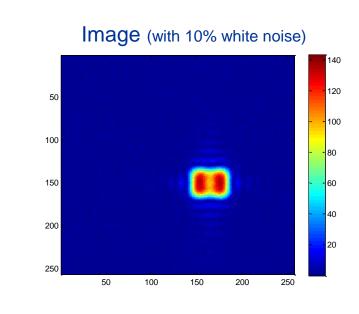
0.3

0.2

0.1

0



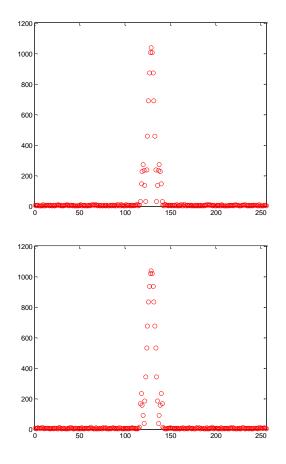


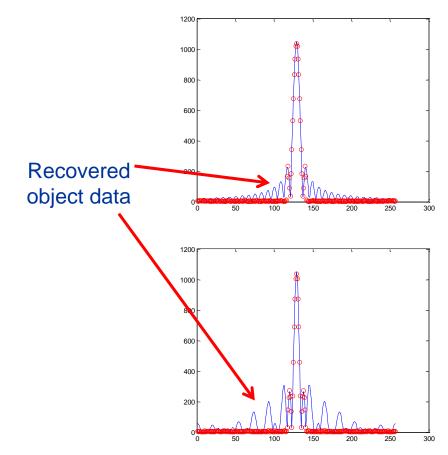
Object not resolved and no evidence of defect



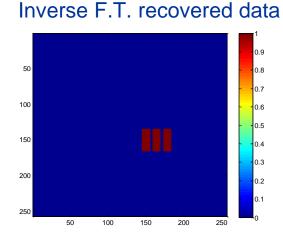
Take Fourier transform of image

Use *a priori* knowledge to fit to Fourier data and extrapolate beyond bandwidth



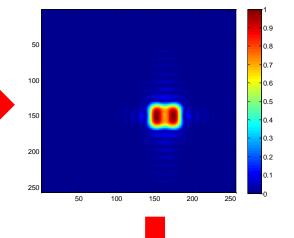




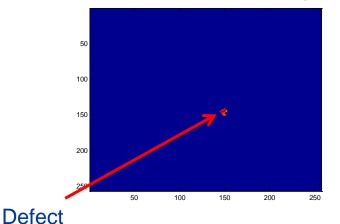


Note: Information regarding defect has not been recovered

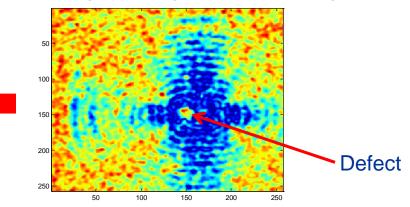
Convolve recovered object data with PSF



Subtract a reference image



Subtract original image from new image





- Early stages for this work at NPL
- Numerical simulations show technique has some promise
- Prototype coherent imaging system under construction to test methods on real image data
- Methods to make data fitting faster & more robust to noise being researched

Other things to look out for



- Intelligent sampling
- Hybrid instrumentation and data fusion
- Compressed sensing
- Amount of data?

. . .

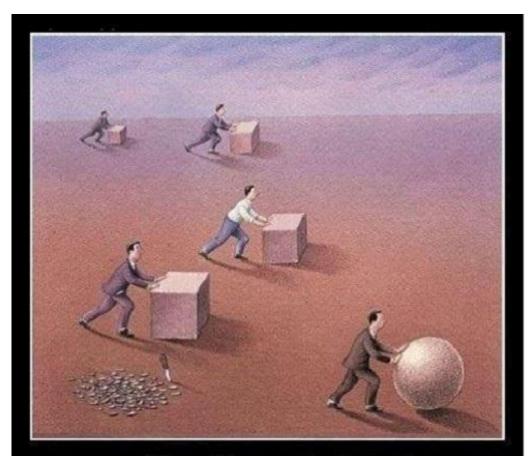
Conclusions



- There has been a great deal of work to develop large area, low resolution form measuring instruments
- and small area, high resolution texture measuring instruments
- We now need to combine the two there is a lot of work to do on basics *plus* working *in* industry
- NPL is actively searching for industry partners to work with in this area – we can potentially match funding using NMS projects

Measure smarter, not harder!



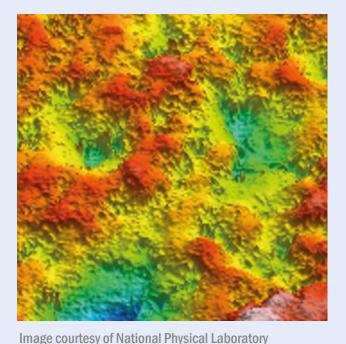


Don't work hard work intelligent

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Optical Measurement of Surface Topography

Richard Leach Editor

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Richard Leach Editor Characterisation of Areal Surface Texture



Description Springer